Beomjin Kwon

List of Publications by Year in descending order

Source: https://exaly.com/author-pdf/191023/publications.pdf

Version: 2024-02-01

361413 377865 1,239 47 20 34 h-index citations g-index papers 47 47 47 1689 docs citations times ranked citing authors all docs

| # | Article | IF | CITATIONS |
|----|---|--------------|-----------|
| 1 | Deep Learning of Forced Convection Heat Transfer. Journal of Heat Transfer, 2022, 144, . | 2.1 | 4 |
| 2 | Machine learning to predict effective reaction rates in 3D porous media from pore structural features. Scientific Reports, 2022, 12, 5486. | 3.3 | 8 |
| 3 | Continuous Nanoparticle Patterning Strategy in Layerâ€Structured Nanocomposite Fibers. Advanced Functional Materials, 2022, 32, . | 14.9 | 5 |
| 4 | A two-dimensional finite element model for Cu-CNT composite: The impact of interface resistances on electrical and thermal transports. Materialia, 2022, 24, 101505. | 2.7 | 1 |
| 5 | Porous organic filler for high efficiency of flexible thermoelectric generator. Nano Energy, 2021, 81, 105604. | 16.0 | 58 |
| 6 | Composition-segmented BiSbTe thermoelectric generator fabricated by multimaterial 3D printing. Nano Energy, 2021, 81, 105638. | 16.0 | 43 |
| 7 | Cu2Se-based thermoelectric cellular architectures for efficient and durable power generation. Nature Communications, 2021, 12, 3550. | 12.8 | 41 |
| 8 | Thermal conductivity of metal coated polymer foam: Integrated experimental and modeling study. International Journal of Thermal Sciences, 2021, 169, 107045. | 4.9 | 9 |
| 9 | Air Jet Impingement Cooling of Electronic Devices Using Additively Manufactured Nozzles. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2020, 10, 220-229. | 2.5 | 52 |
| 10 | Machine learning for heat transfer correlations. International Communications in Heat and Mass Transfer, 2020, 116, 104694. | 5 . 6 | 64 |
| 11 | A composite phase change material thermal buffer based on porous metal foam and low-melting-temperature metal alloy. Applied Physics Letters, 2020, 116, . | 3 . 3 | 31 |
| 12 | Computationally efficient optimization of wavy surface roughness in cooling channels using simulated annealing. International Journal of Heat and Mass Transfer, 2020, 150, 119300. | 4.8 | 9 |
| 13 | Heuristic Optimization of Ribbed Cooling Channels With Variable Length and Roughness. Journal of Heat Transfer, 2020, 142, . | 2.1 | 1 |
| 14 | Machine learning flow regime classification in three-dimensional printed tubes. Physical Review Fluids, 2020, 5, . | 2.5 | 1 |
| 15 | Optimization of Liquid Cooling Microchannel in 3D IC using Complete Converging and Diverging Channel Models., 2019,,. | | 2 |
| 16 | An Integrated Liquid Metal Thermal Switch for Active Thermal Management of Electronics. IEEE Transactions on Components, Packaging and Manufacturing Technology, 2019, 9, 2341-2351. | 2.5 | 28 |
| 17 | Heat transfer enhancement of internal laminar flows using additively manufactured static mixers. International Journal of Heat and Mass Transfer, 2019, 137, 292-300. | 4.8 | 47 |
| 18 | High power density two-phase cooling in microchannel heat exchangers. Applied Thermal Engineering, 2019, 148, 1271-1277. | 6.0 | 17 |

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|----|--|------|-----------|
| 19 | Millimeter-scale liquid metal droplet thermal switch. Applied Physics Letters, 2018, 112, . | 3.3 | 44 |
| 20 | 3D printing of shape-conformable thermoelectric materials using all-inorganic Bi2Te3-based inks. Nature Energy, 2018, 3, 301-309. | 39.5 | 237 |
| 21 | High power density air-cooled microchannel heat exchanger. International Journal of Heat and Mass Transfer, 2018, 118, 1276-1283. | 4.8 | 21 |
| 22 | Accurate Models for Optimizing Tapered Microchannel Heat Sinks in 3D ICs., 2018,,. | | 6 |
| 23 | Design and Experimental Investigation of Thermoelectric Generators for Wearable Applications. Advanced Materials Technologies, 2017, 2, 1600292. | 5.8 | 28 |
| 24 | Microscale transport physics during atomic force microscopy mass spectrometry and improved sampling efficiency. , 2017, , . | | 0 |
| 25 | Harman Measurements for Thermoelectric Materials and Modules under Non-Adiabatic Conditions. Scientific Reports, 2016, 6, 39131. | 3.3 | 19 |
| 26 | Effect of spark plasma sintering conditions on the thermoelectric properties of (Bi0.25Sb0.75)2Te3 alloys. Journal of Alloys and Compounds, 2016, 678, 396-402. | 5.5 | 25 |
| 27 | Correction of the Electrical and Thermal Extrinsic Effects in Thermoelectric Measurements by the Harman Method. Scientific Reports, 2016, 6, 26507. | 3.3 | 11 |
| 28 | Enhancement of Mechanical Hardness in $SnO(sub)(i)x(i)(sub)N(sub)(i)y(i)(sub)$ with a Dense High-Pressure Cubic Phase of $SnO(sub)(sub)(s$ | 6.7 | 23 |
| 29 | High-performance shape-engineerable thermoelectric painting. Nature Communications, 2016, 7, 13403. | 12.8 | 122 |
| 30 | Free-electron creation at the $60 \hat{A}^{\circ}$ twin boundary in Bi2Te3. Nature Communications, 2016, 7, 12449. | 12.8 | 59 |
| 31 | Glancing angle deposited WO 3 nanostructures for enhanced sensitivity and selectivity to NO 2 in gas mixture. Sensors and Actuators B: Chemical, 2016, 229, 92-99. | 7.8 | 28 |
| 32 | Thickness-Dependent Electrocaloric Effect in Pb0.9La0.1Zr0.65Ti0.35O3 Films Grown by Sol–Gel Process. Journal of Electronic Materials, 2016, 45, 1057-1064. | 2.2 | 12 |
| 33 | Giant Electroresistive Ferroelectric Diode on 2DEG. Scientific Reports, 2015, 5, 10548. | 3.3 | 10 |
| 34 | Hardening of Bi–Te based alloys by dispersing B4C nanoparticles. Acta Materialia, 2015, 97, 68-74. | 7.9 | 19 |
| 35 | Electric-field-induced Shift in the Threshold Voltage in LaAlO3/SrTiO3 Heterostructures. Scientific Reports, 2015, 5, 8023. | 3.3 | 13 |
| 36 | Effect of Sn Doping on the Thermoelectric Properties of n-type Bi2(Te,Se)3 Alloys. Journal of Electronic Materials, 2015, 44, 1926-1930. | 2.2 | 8 |

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|----|---|-----|-----------|
| 37 | A differential method for measuring cooling performance of a thermoelectric module. Applied Thermal Engineering, 2015, 87, 209-213. | 6.0 | 3 |
| 38 | Sn doping in thermoelectric Bi2Te3 films by metal-organic chemical vapor deposition. Applied Surface Science, 2015, 353, 232-237. | 6.1 | 18 |
| 39 | Thermoelectric Properties of Sn-Doped Bi0.4Sb1.6Te3 Thin Films. Journal of Electronic Materials, 2015, 44, 1573-1578. | 2.2 | 3 |
| 40 | Dynamic temperature response of electrocaloric multilayer capacitors. Applied Physics Letters, 2014, 104, . | 3.3 | 11 |
| 41 | Impact of parasitic thermal effects on thermoelectric property measurements by Harman method. Review of Scientific Instruments, 2014, 85, 045108. | 1.3 | 21 |
| 42 | SnO 2 thin films grown by atomic layer deposition using a novel Sn precursor. Applied Surface Science, 2014, 320, 188-194. | 6.1 | 35 |
| 43 | Electrocaloric Effect in Pb _{0.865} 1.500.092.500.093550.3590 ₃ 71 _{90<su< td=""><td>0.2</td><td>1</td></su<>}}} | 0.2 | 1 |
| 44 | Bimaterial microcantilevers with black silicon nanocone arrays. Sensors and Actuators A: Physical, 2013, 199, 143-148. | 4.1 | 13 |
| 45 | Large infrared absorptance of bimaterial microcantilevers based on silicon high contrast grating. Journal of Applied Physics, 2013, 114, 153511. | 2.5 | 3 |
| 46 | Dynamic thermomechanical response of bimaterial microcantilevers to periodic heating by infrared radiation. Review of Scientific Instruments, 2012, 83, 015003. | 1.3 | 20 |
| 47 | Impact of silicon nitride thickness on the infrared sensitivity of silicon nitride–aluminum microcantilevers. Sensors and Actuators A: Physical, 2012, 185, 17-23. | 4.1 | 5 |